

L Number	Hits	Search Text	DB	Time stamp
1	2117	438/643.ccls. 438/758.ccls. 118/503.ccls. 118/707.ccls.	USPAT	2004/08/21 17:27
-	2098	"deposition chamber".clm.	USPAT; US-PGPUB; EPO; JPO	2004/08/21 17:23
-	1290	"plasma chamber".clm.	USPAT; US-PGPUB; EPO; JPO	2004/05/26 08:04
-	3324	"deposition chamber".clm. "plasma chamber".clm.	USPAT; US-PGPUB; EPO; JPO	2004/05/26 08:14
-	67458	robot\$1	USPAT; US-PGPUB; EPO; JPO	2004/05/26 08:14
-	9524	third adj2 chamber	USPAT; US-PGPUB; EPO; JPO	2004/05/26 08:15
-	30	("deposition chamber".clm. "plasma chamber".clm.) and robot\$1 and (third adj2 chamber)	USPAT; US-PGPUB; EPO; JPO	2004/05/26 08:15
-	59308	tantalum "tantalum nitride"	USPAT; US-PGPUB; EPO; JPO	2004/05/26 08:16
-	5746	"native oxide" (native adj2 oxide)	USPAT; US-PGPUB; EPO; JPO	2004/08/20 13:13
-	430150	copper	USPAT; US-PGPUB; EPO; JPO	2004/05/26 08:17
-	418	(tantalum "tantalum nitride") and ("native oxide" (native adj2 oxide)) and copper	USPAT; US-PGPUB; EPO; JPO	2004/05/26 08:17
-	0	((tantalum "tantalum nitride") and ("native oxide" (native adj2 oxide)) and copper) and ("deposition chamber".clm. "plasma chamber".clm.) and robot\$1 and (third adj2 chamber))	USPAT; US-PGPUB; EPO; JPO	2004/05/26 08:17
-	23	((tantalum "tantalum nitride") and ("native oxide" (native adj2 oxide)) and copper) and ("deposition chamber".clm. "plasma chamber".clm.)	USPAT; US-PGPUB; EPO; JPO	2004/05/26 08:17
-	8	"ndr element"	USPAT; US-PGPUB; EPO; JPO	2004/05/27 12:21
-	0	(control adjust hold)\$3	USPAT; US-PGPUB; EPO; JPO	2004/05/27 12:23
-	0	control1\$3 adjust\$3 hold\$3	USPAT; US-PGPUB; EPO; JPO	2004/05/27 12:26
-	0	(control1\$3 adjust\$3 hold\$3).clm.	USPAT; US-PGPUB; EPO; JPO	2004/05/27 12:26
-	0	control\$3 adj2 (impurity impurities boron)	USPAT; US-PGPUB; EPO; JPO	2004/05/27 12:26
-	3	("5934856" "5996353" "6136725").pn.	USPAT; US-PGPUB; EPO; JPO	2004/08/20 13:11
-	3	((("5934856" "5996353" "6136725").pn.) and heat\$3	USPAT; US-PGPUB; EPO; JPO	2004/08/20 14:45
-	0	((("5934856" "5996353" "6136725").pn.) and heat\$3) and ("native oxide" (native adj2 oxide))	USPAT; US-PGPUB; EPO; JPO	2004/08/20 13:13
-	1	(US-6136725-\$).did.	USPAT	2004/08/20 14:45

-	1	((US-6136725-\$).did.) and tantalum	USPAT; US-PGPUB; EPO; JPO	2004/08/20 14:45
-	1	((US-6136725-\$).did.) and tantalum) and copper	USPAT; US-PGPUB; EPO; JPO	2004/08/20 14:55
-	2002	"cluster tool"	USPAT; US-PGPUB; EPO; JPO	2004/08/20 14:55